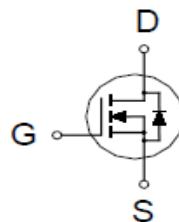
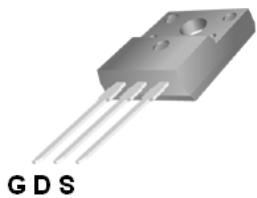


P8315ATF

N-Channel Enhancement Mode MOSFET

PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
150V	83mΩ @ $V_{GS} = 10V$	13.5A



TO-220F

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ C$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS	SYMBOL	LIMITS	UNITS
Drain-Source Voltage	V_{DS}	150	V
Gate-Source Voltage	V_{GS}	± 30	
Continuous Drain Current $T_c = 25^\circ C$	I_D	13.5	A
		8.5	
Pulsed Drain Current ¹	I_{DM}	50	
Avalanche Current	I_{AS}	17	
Avalanche Energy ²	E_{AS}	163	mJ
Power Dissipation $T_c = 25^\circ C$	P_D	35	W
		14	
Junction & Storage Temperature Range	T_J, T_{stg}	-55 to 150	°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	$R_{\theta JC}$	3.6	62.5	°C / W
Junction-to-Ambient	$R_{\theta JA}$			

¹Pulse width limited by maximum junction temperature.

²Starting $T_j = 25^\circ C, I_{AS} = 17A, L = 1.1mH, V_{DD} = 50V$



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ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$, Unless Otherwise Noted)

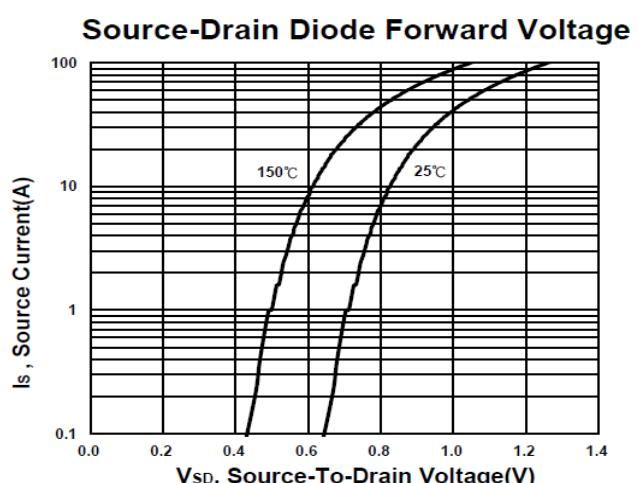
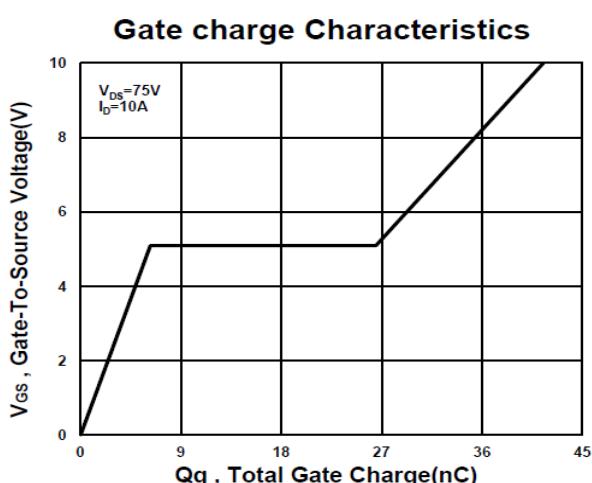
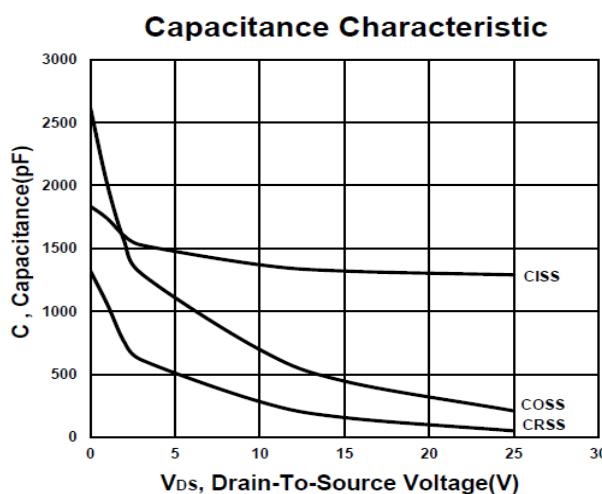
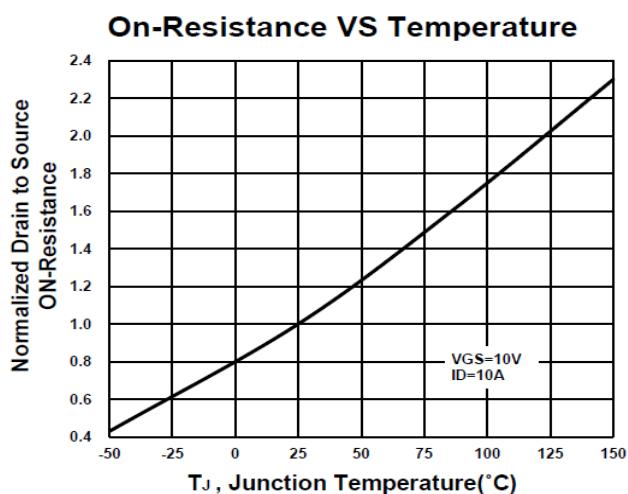
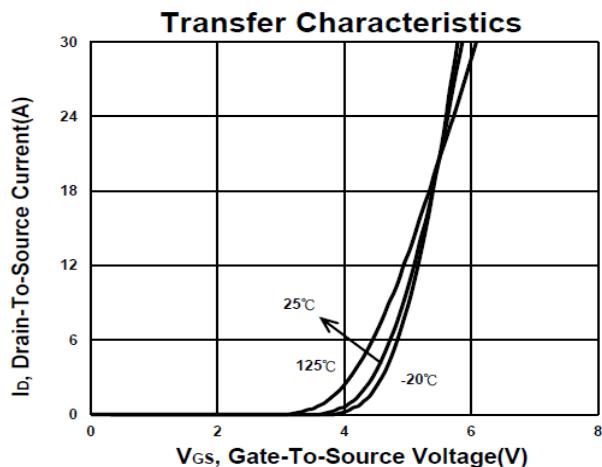
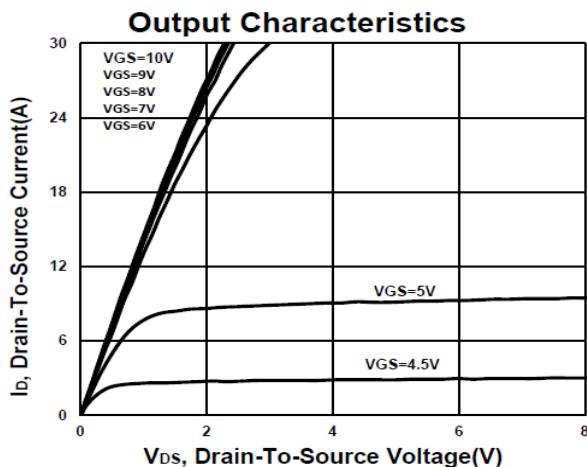
PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNITS
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	150			V
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	2	3	4	
Gate-Body Leakage	I_{GSS}	$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = \pm 30\text{V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = 120\text{V}, V_{\text{GS}} = 0\text{V}$			1	μA
		$V_{\text{DS}} = 100\text{V}, V_{\text{GS}} = 0\text{V}, T_J = 125^\circ\text{C}$			10	
Drain-Source On-State Resistance ¹	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}} = 10\text{V}, I_D = 10\text{A}$		64	83	$\text{m}\Omega$
		$V_{\text{GS}} = 7\text{V}, I_D = 10\text{A}$		68	88	
Forward Transconductance ¹	g_{fs}	$V_{\text{DS}} = 10\text{V}, I_D = 10\text{A}$		15		S
DYNAMIC						
Input Capacitance	C_{iss}	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 25\text{V}, f = 1\text{MHz}$		1290		pF
Output Capacitance	C_{oss}			208		
Reverse Transfer Capacitance	C_{rss}			51		
Total Gate Charge ²	Q_g	$V_{\text{GS}} = 10\text{V}, V_{\text{DS}} = 75\text{V}, I_D = 10\text{A}$		41.7		nC
Gate-Source Charge ²	Q_{gs}			6.7		
Gate-Drain Charge ²	Q_{gd}			20.7		
Turn-On Delay Time ²	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 75\text{V}, I_D \geq 10\text{A}, V_{\text{GS}} = 10\text{V}, R_{\text{GEN}} = 6\Omega$		14		nS
Rise Time ²	t_r			50		
Turn-Off Delay Time ²	$t_{\text{d}(\text{off})}$			48		
Fall Time ²	t_f			38		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_J = 25^\circ\text{C}$)						
Continuous Current	I_S				13.5	A
Forward Voltage ¹	V_{SD}	$I_F = 10\text{A}, V_{\text{GS}} = 0\text{V}$			1.6	V
Reverse Recovery Time	t_{rr}	$I_F = 10\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$		122		nS
Reverse Recovery Charge	Q_{rr}			620		nC

¹Pulse test : Pulse Width $\leq 300\ \mu\text{sec}$, Duty Cycle $\leq 2\%$.

²Independent of operating temperature.

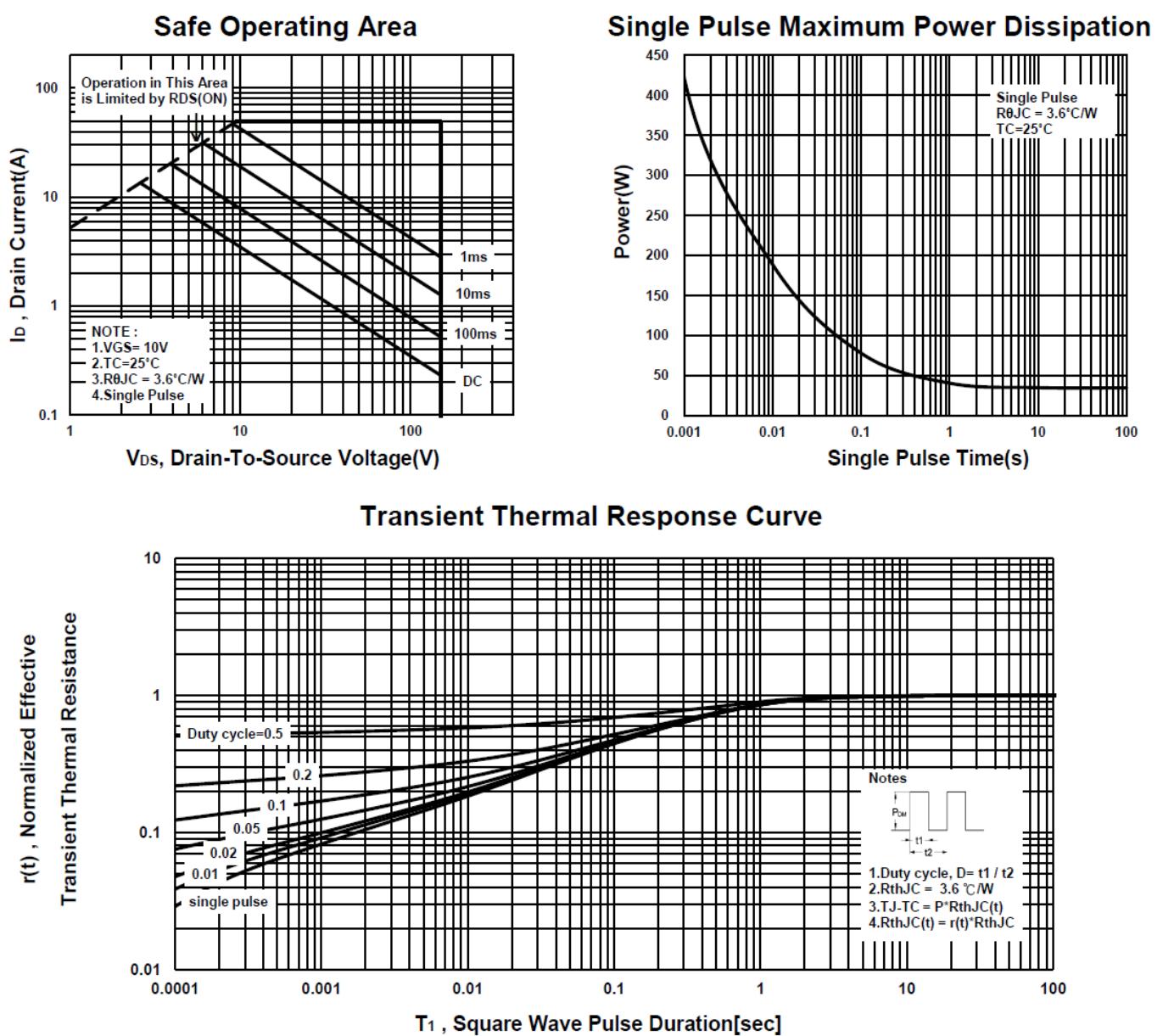
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Package Dimension

TO-220F (3-Lead) MECHANICAL DATA

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	4.2		4.93	e	2.05	2.55	3.05
A1	2.34		3.1	F	27.45		30.6
B	17.77		20.3	G	7.72		9.3
b	0.6		1.05	H	6.1		7.1
b1	0.9	1.23	1.62	L	12.5		14.5
b2	0.6		1.9	L1	1.97		3.8
c	0.4		1.0	P	2.98		3.4
D	14.7		16.4	Q	2.1		2.96
D1	6.4		7.5	q	3.0		3.8
E	9.7		10.4				

